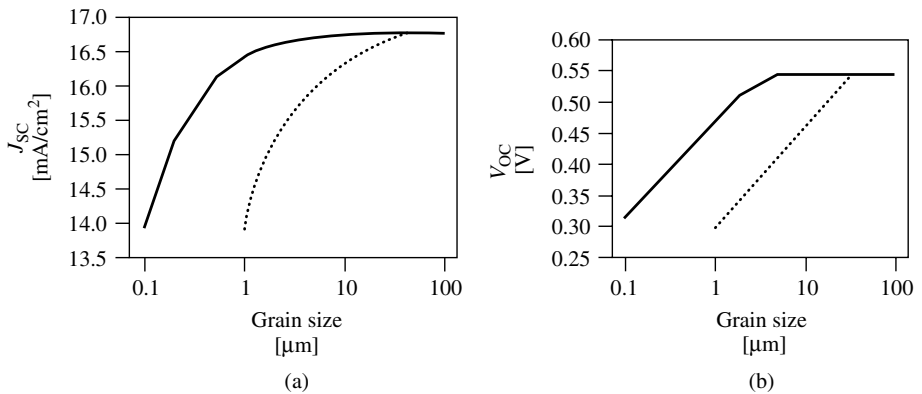


**Figure 8.23** The proposed model of different regions in an  $n-p$  junction built on imperfect material. (a) The model of Type I, II, and IV regions, and the relationship among them inside a device. (b) The junction at the interface of Type I, II, IV region, and Type III region.  $J_1$  and  $J_2$  are current flows discussed in Reference [19]. The distribution of carriers inside the Type III region is not considered



**Figure 8.24** Calculated dependence of (a)  $J_{SC}$ ; and (b)  $V_{OC}$  on the grain size of the  $10\text{-}\mu\text{m}$ -thick cell for two values of interface recombination velocity,  $100\text{ cm/s}$  (solid lines) and  $1000\text{ cm/s}$  (dotted lines)